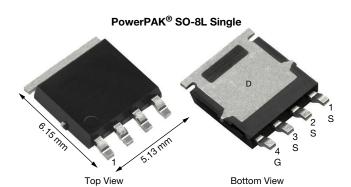


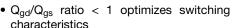
N-Channel 25 V (D-S) MOSFET



PRODUCT SUMMARY						
V _{DS} (V)	25					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.00074					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.00140					
Q _g typ. (nC)	39					
I _D (A) ^a	201					
Configuration	Single					

FEATURES

- TrenchFET® Gen IV power MOSFET
- \bullet Tuned for the lowest $R_{DS}\text{-}Q_{oss}$ FOM
- 100 % Rq and UIS tested

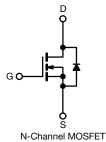






APPLICATIONS

- · Synchronous rectification
- High power density DC/DC
- Hot-swap switch and OR-ing FET
- · Battery and load switch



ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SiJA22DP-T1-GE3

ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, unles	s otherwise no	oted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	25	V	
Gate-source voltage		V_{GS}	+20, -16	V	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		201		
	T _C = 70 °C		161	•	
	T _A = 25 °C	l _D	64 ^{b, c}		
	T _A = 70 °C		51 ^{b, c}		
Pulsed drain current (t = 100 μs)		I _{DM}	160	A	
Continuous source-drain diode current	T _C = 25 °C		43.6		
Continuous source-drain diode current	T _A = 25 °C	l _S	4.3 ^{b, c}		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	50		
Single pulse avalanche energy	L = 0.1 IIII1	E _{AS}	125	mJ	
	T _C = 25 °C		48		
Maximum power dissipation	T _C = 70 °C	р	30.7	w	
	T _A = 25 °C	P _D	4.8 b, c	VV	
	T _A = 70 °C]	3 b, c		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) d, e			260	C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b, f	t ≤ 10 s	R_{thJA}	22	26	°C/W
Maximum junction-to-case (drain)	Steady state	R_{thJC}	1.7	2.6	5/ ٧٧

Notes

- a. $T_C = 25 \,^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- t = 10 s
- See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

 Rework conditions: manual soldering with a soldering iron is not recommended for leadless component Maximum under steady state conditions is 70 °C/W



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	<u> </u>		1				
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	25	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 10 mA	-	15.8	-	1400	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$			-5.1	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.1	-	2.2	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = +20, -16 \text{ V}$	-	-	± 100	nA	
		V _{DS} = 25 V, V _{GS} = 0 V	-	-	1		
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	-	-	10	μA	
On-state drain current a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	Α	
.		$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	0.00057	0.00074	4	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	-	0.00103	0.00140	Ω	
Forward transconductance a	9 _{fs}	V _{DS} = 10 V, I _D = 25 A	-	155	-	S	
Dynamic ^b		·					
Input capacitance	C _{iss}		-	6500	-		
Output capacitance	C _{oss}		-	2250	-	рF	
Reverse transfer capacitance	C _{rss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	202	-	.در	
C _{rss} /C _{iss} ratio			-	0.031	-		
7155 7155 71117	Q _g	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 15 \text{ A}$	-	83	125	nC	
Total gate charge			-	39	59		
Gate-source charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 15 \text{ A}$	-	18	-		
Gate-drain charge	Q _{qd}	20 . 00	_	9.8	-		
Output charge	Q _{oss}	V _{DS} = 15 V, V _{GS} = 0 V	-	57	86		
Gate resistance	R _q	f = 1 MHz	0.2	1.0	2.0	Ω	
Turn-on delay time	t _{d(on)}		-	15	30		
Rise time	t _r	V_{DD} = 10 V, R_L = 1 Ω	-	6	12	1	
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	39	80		
Fall time	t _f		_	6	12		
Turn-on delay time	t _{d(on)}		-	37	80	ns	
Rise time	t _r	$V_{DD} = 10 \text{ V}, R_{I} = 1 \Omega$	-	78	160	-	
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	41	80		
Fall time	t _f		-	15	30		
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	43.6		
Pulse diode forward current (t = 100 μs)	I _{SM}		-	-	160	Α	
Body diode voltage	V _{SD}	I _S = 10 A	-	0.74	1.1	V	
Body diode reverse recovery time	t _{rr}	-	-	50	100	ns	
Body diode reverse recovery charge	Q _{rr}	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	60	120	nC	
Reverse recovery fall time	t _a	$T_J = 25 ^{\circ}\text{C}$	-	27	-		
Reverse recovery rise time	t _b		-	23	_	ns	

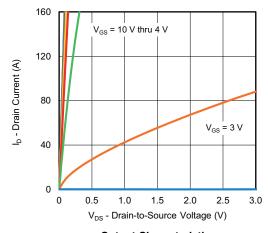
Notes

- a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing

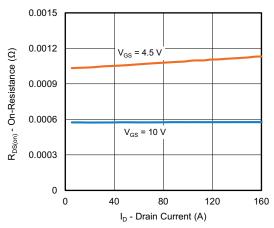
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



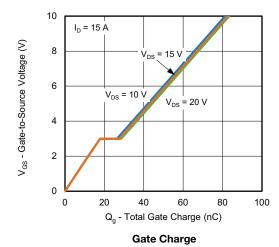
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

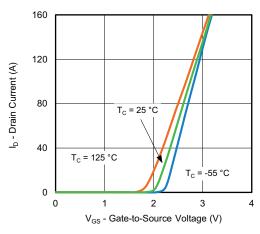


Output Characteristics

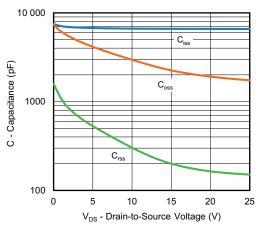


On-Resistance vs. Drain Current

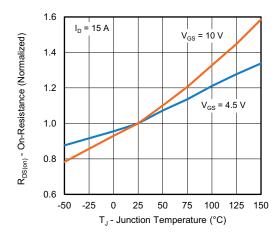




Transfer Characteristics



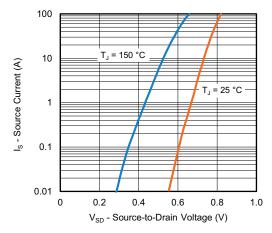
Capacitance



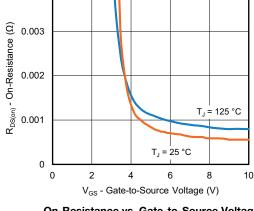
On-Resistance vs. Junction Temperature



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

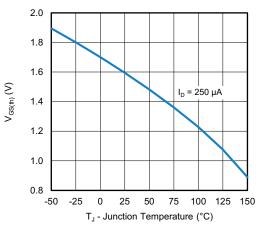


Source-Drain Diode Forward Voltage

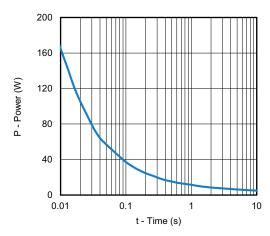


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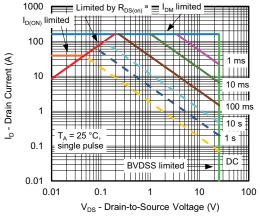
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



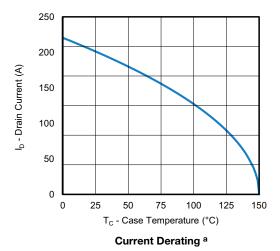
Single Pulse Power, Junction-to-Ambient

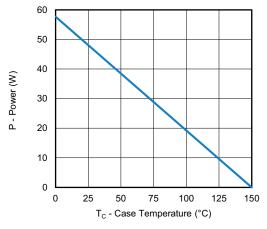


Safe Operating Area

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





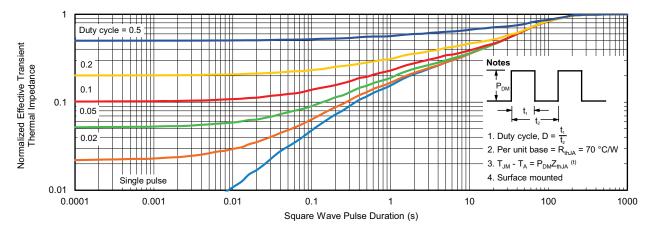
Power, Junction-to-Case

Note

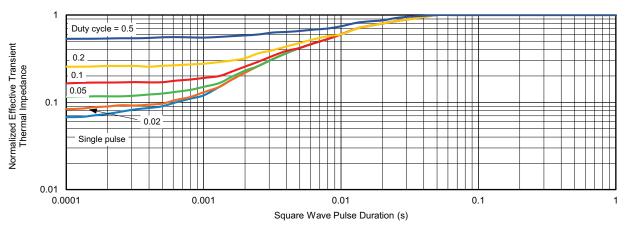
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

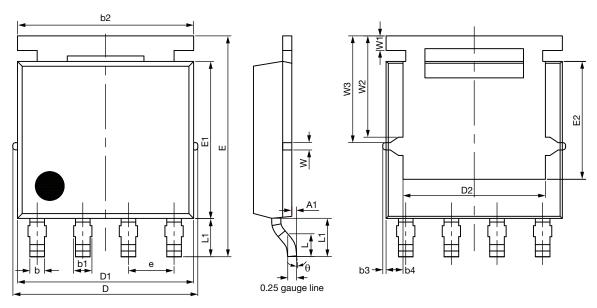


Normalized Thermal Transient Impedance, Junction-to-Case

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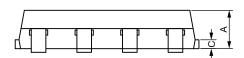


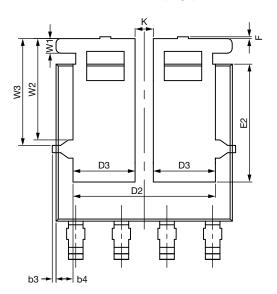
PowerPAK® SO-8L Case Outline 1



Topside view

Backside view (single)





Backside view (dual)



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DIM	MILLIMETERS		INCHES				
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094	•		0.004		
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC	•	0.050 BSC			
Е	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	3.18	3.28	3.38	0.125	0.129	0.133	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
K		0.51			0.020		
W		0.23			0.009		
W1	0.41			0.016			
W2		2.82			0.111		
W3		2.96			0.117		
θ	0°	-	10°	0°	-	10°	

ECN: S19-0643-Rev. E, 05-Aug-2019

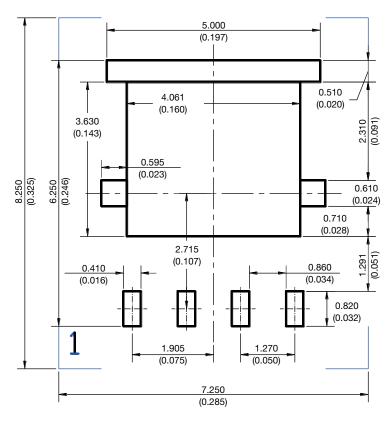
DWG: 5976

Note

• Millimeters will gover



RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)



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